

DATA SHEET

CBT3244

Octal bus switch with quad output enables

Product data
Supersedes data of 2002 May 28

2003 Feb 20

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FEATURES

- Standard '244-type pinout
- 5 Ω switch connection between two ports
- TTL compatible control input levels
- Package options include plastic small outline (D), shrink small outline (DB), QSOP (DS), thin shrink small outline (TSSOP)
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101

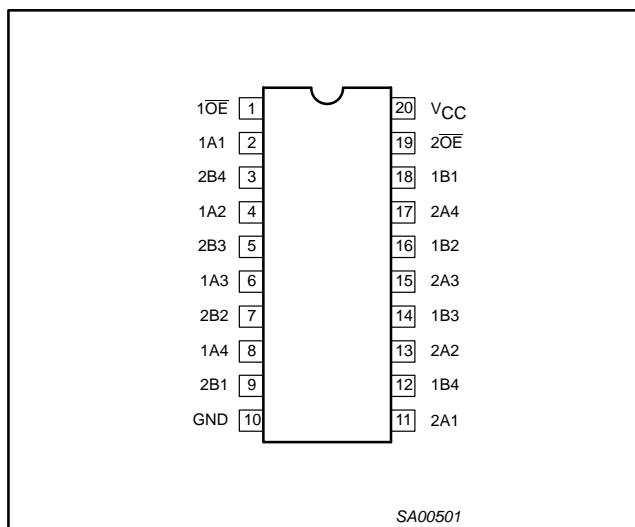
DESCRIPTION

The CBT3244 provides eight bits of high-speed TTL-compatible bus switching in a standard '244 device pinout. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The CBT3244 device is organized as two 4-bit low-impedance switches with separate output-enable (OE) inputs. When \overline{OE} is low, the switch is on and data can flow from port A to port B, or vice versa. When \overline{OE} is high, the switch is open and high-impedance state exists between the two ports.

The CBT3244 is characterized for operation from -40 to 85 $^{\circ}\text{C}$.

PIN CONFIGURATION



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 19	$1\overline{OE}$, $2\overline{OE}$	Output enable
2, 4, 6, 8	1A1-1A4	Inputs
11, 13, 15, 17	2A1-2A4	Inputs
18, 16, 14, 12	1B1-1B4	Outputs
9, 7, 5, 3	2B1-2B4	Outputs
10	GND	Ground (0V)
20	V_{CC}	Positive supply voltage

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25^{\circ}\text{C}$; $GND = 0\text{ V}$	TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay An to Yn	$C_L = 50\text{ pF}$; $V_{CC} = 5\text{ V}$	250	ps
$C_{IO(OFF)}$	Pin capacitance (OFF state)	$V_O = 3\text{ V}$ or 0 V	6	pF
I_{CC}	Quiescent supply current	$V_{CC} = 5.5\text{ V}$; $I_O = 0$; $V_I = V_{CC}$ or GND	1	μA

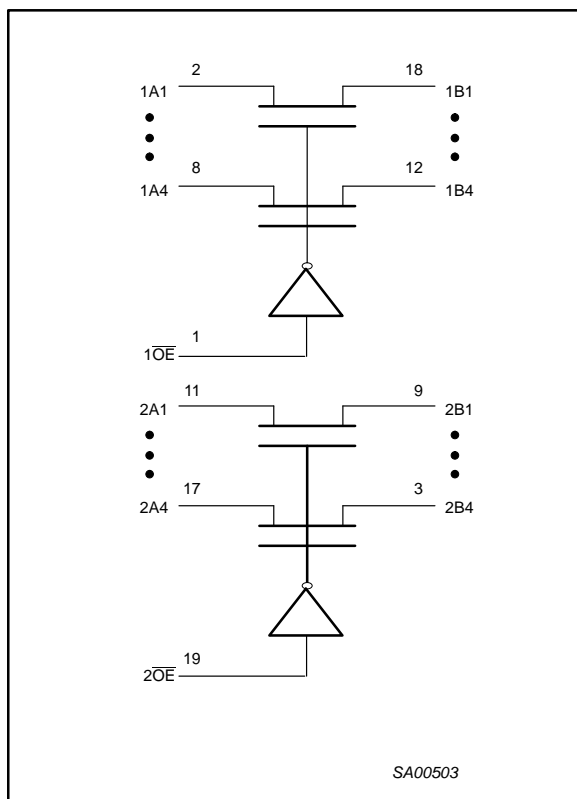
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
20-Pin Plastic TSSOP	-40 to 85 $^{\circ}\text{C}$	CBT3244PW	SOT360-1
20-Pin Plastic SSOP (QSOP)	-40 to 85 $^{\circ}\text{C}$	CBT3244DS	SOT556-1
20-Pin Plastic SSOP	-40 to 85 $^{\circ}\text{C}$	CBT3244DB	SOT339-1
20-Pin Plastic SO	-40 to 85 $^{\circ}\text{C}$	CBT3244D	SOT163-1

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LOGIC SYMBOL



FUNCTION TABLE

INPUTS		OUTPUTS	
1OE	2OE	1A, 1B	2A, 2B
L	L	1A = 1B	2A = 2B
L	H	1A = 1B	Z
H	L	Z	2A = 2B
H	H	Z	Z

H = High voltage level
 L = Low voltage level
 Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current	V _I < 0	-18	mA
V _I	DC input voltage ³		-1.2 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +7	V
I _{OUT}	DC output current	output in Low state	128	mA
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		Min	Max	
V_{CC}	DC supply voltage	4.5	5.5	V
V_{IH}	High-level input voltage	2.0	—	V
V_{IL}	Low-level Input voltage	—	0.8	V
T_{amb}	Operating free-air temperature range	-40	+85	°C

DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			$T_{amb} = -40 \text{ to } +85 \text{ } ^\circ\text{C}$			
			Min	Typ ¹	Max	
V_{IK}	Input clamp voltage	$V_{CC} = 4.5 \text{ V}; I_I = -18 \text{ mA}$	—	—	-1.2	V
I_I	Input leakage current	$V_{CC} = 5.5 \text{ V}; V_I = \text{GND or } 5.5 \text{ V}$	—	—	± 5	μA
I_{CC}	Quiescent supply current	$V_{CC} = 5.5 \text{ V}; I_O = 0, V_I = V_{CC} \text{ or GND}$	—	1	3	μA
ΔI_{CC}	Additional supply current per input pin ²	$V_{CC} = 5.5 \text{ V}$, one input at 3.4 V, other inputs at V_{CC} or GND	—	—	3.5	mA
C_I	Control pins	$V_I = 3 \text{ V or } 0, \overline{OE} = V_{CC}$	—	3	—	pF
$C_{IO(OFF)}$	Power-off leakage current	$V_O = 3 \text{ V or } 0$	—	6	—	pF
r_{on}^3	On-resistance	$V_{CC} = 4.5 \text{ V}; V_1 = 0 \text{ V}; I_I = 64 \text{ mA}$	—	5	7	Ω
		$V_{CC} = 4.5 \text{ V}; V_1 = 0 \text{ V}; I_I = 30 \text{ mA}$	—	5	7	
		$V_{CC} = 4.5 \text{ V}; V_1 = 0 \text{ V}; I_I = 15 \text{ mA}$	—	10	15	

NOTES:

- All typical values are at $V_{CC} = 5 \text{ V}$, $T_{amb} = 25 \text{ } ^\circ\text{C}$
- This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND
- Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

AC CHARACTERISTICS

GND = 0 V; t_R ; $C_L = 50 \text{ pF}$

SYMBOL	PARAMETER	FROM (INPUT)	TO (OUTPUT)	74CBT3244		UNIT
				$T_{amb} = -40 \text{ to } +85 \text{ } ^\circ\text{C}$ $V_{CC} = +5.0 \text{ V } \pm 0.5 \text{ V}$		
				Min	Max	
t_{pd}	Propagation delay ¹	A or B	B or A	—	.25	ns
t_{en}	Output enable time to High and Low level	OE	A or B	1.0	6.3	ns
t_{dis}	Output disable time from High and Low level	OE	A or B	1.0	6.0	ns

NOTE:

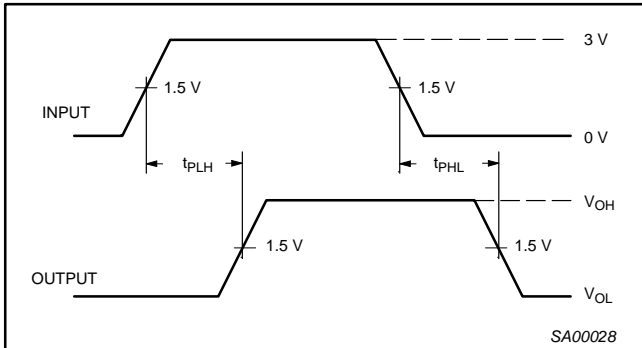
- This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

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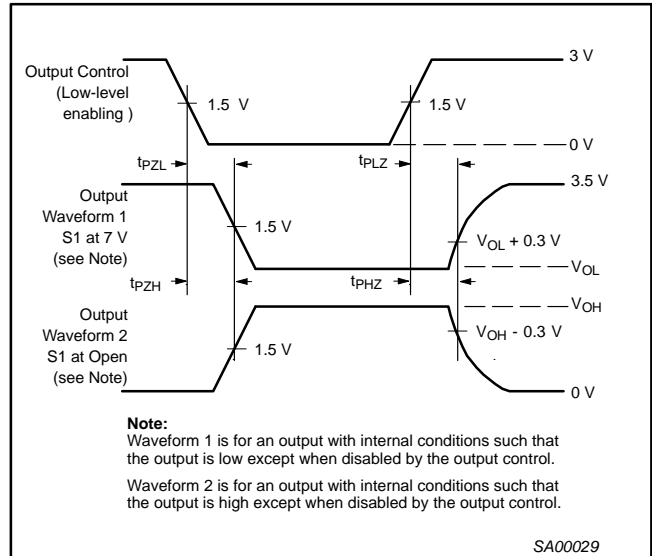
CBT3244

AC WAVEFORMS

$V_M = 1.5\text{ V}$, $V_{IN} = \text{GND to } 3.0\text{ V}$

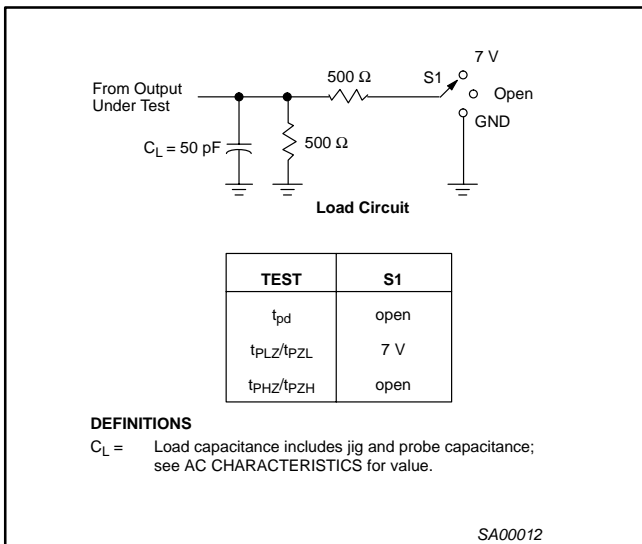


Waveform 1. Input to Output Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORMS



NOTES:

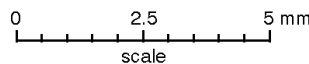
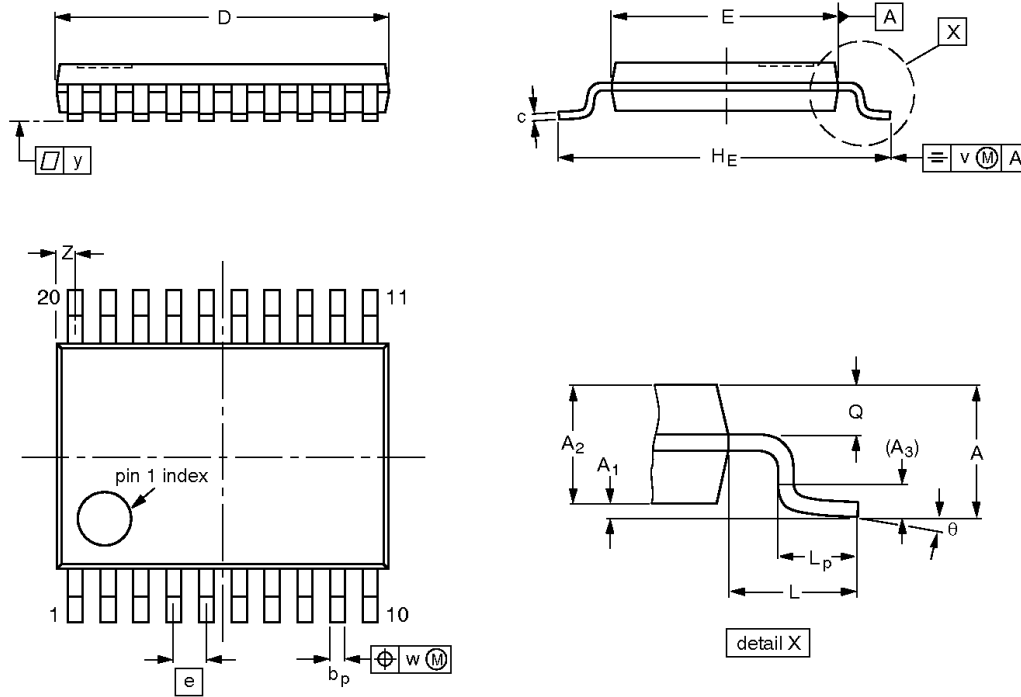
1. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
2. The outputs are measured one at a time with one transition per measurement.

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

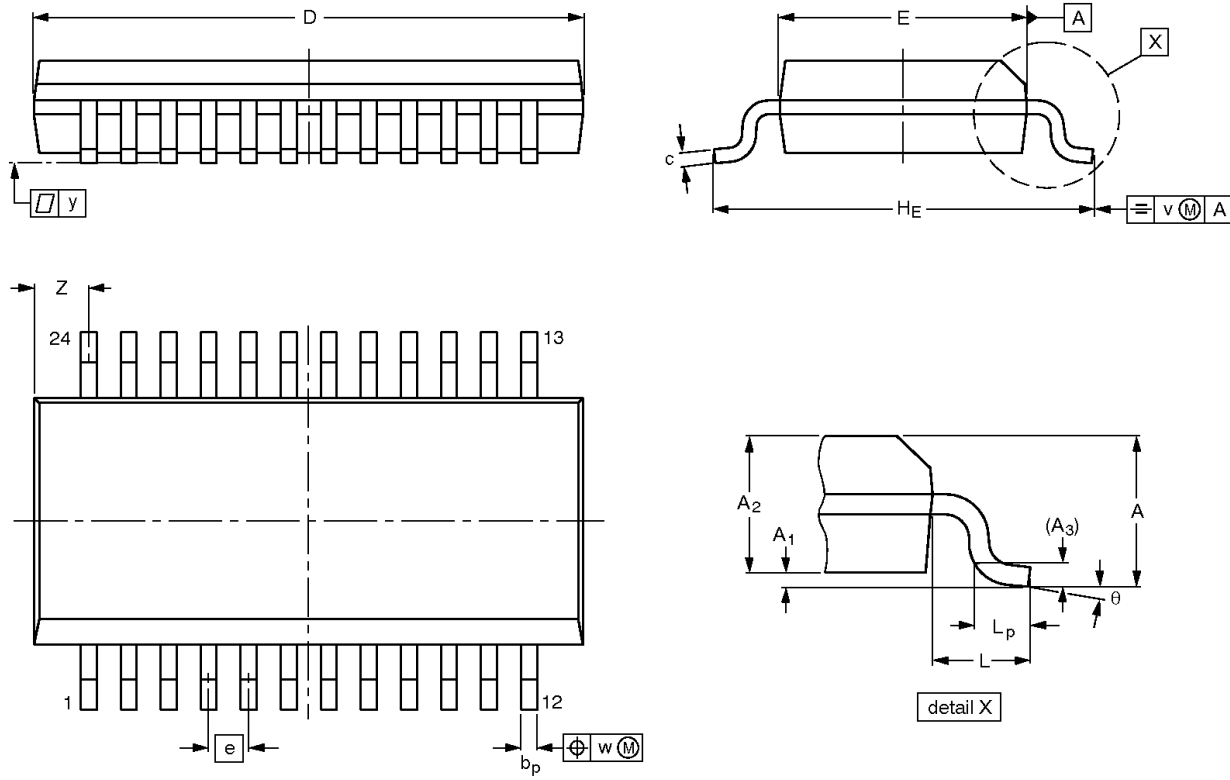
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT360-1		MO-153				95-02-04 99-12-27

Octal bus switch with quad output enables

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SSOP24: plastic shrink small outline package; 24 leads;
body width 3.9 mm; lead pitch 0.635 mm

SOT556-1



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	v	w	y	Z ⁽¹⁾	θ
mm	1.73	0.25 0.10	1.55 1.40	0.25	0.31 0.20	0.25 0.18	8.8 8.6	4.0 3.8	0.635	6.2 5.8	1.0	0.89 0.41	0.25	0.18	0.1	1.05 0.66	8° 0°
inches	0.068	0.0098 0.0040	0.061 0.055	0.010	0.012 0.008	0.0098 0.0075	0.344 0.337	0.157 0.150	0.025	0.244 0.228	0.041	0.035 0.016	0.010	0.007	0.004	0.040 0.026	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

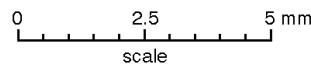
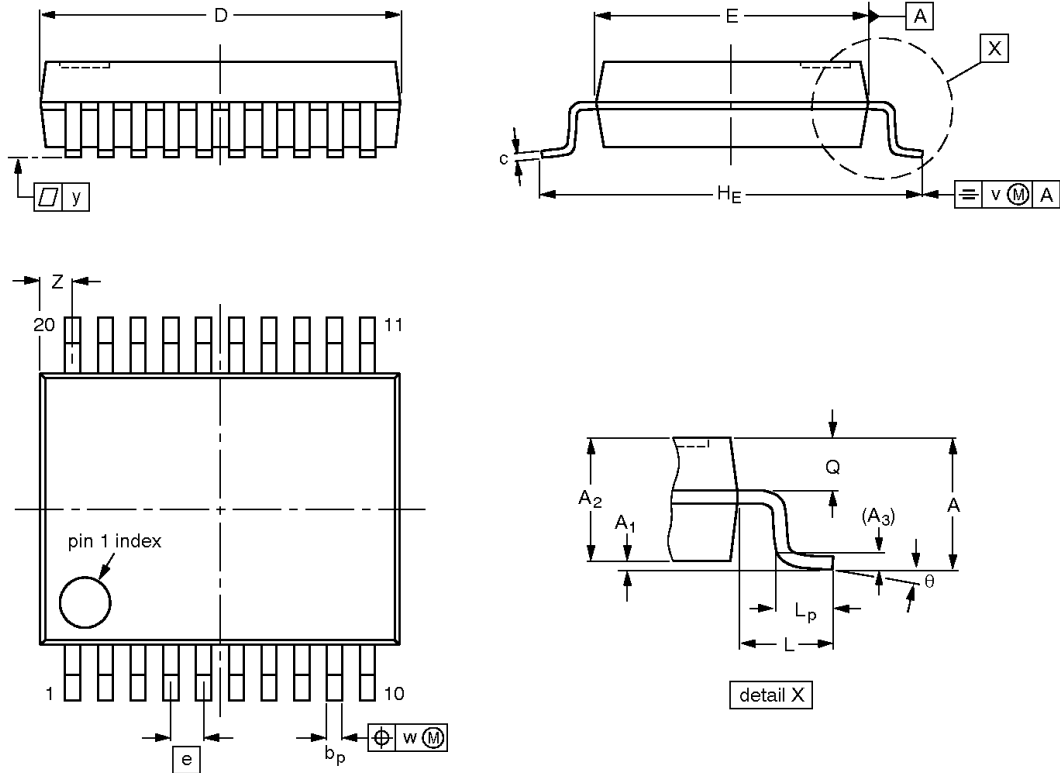
OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOT556-1		MO-137			99-05-05- 99-12-27

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

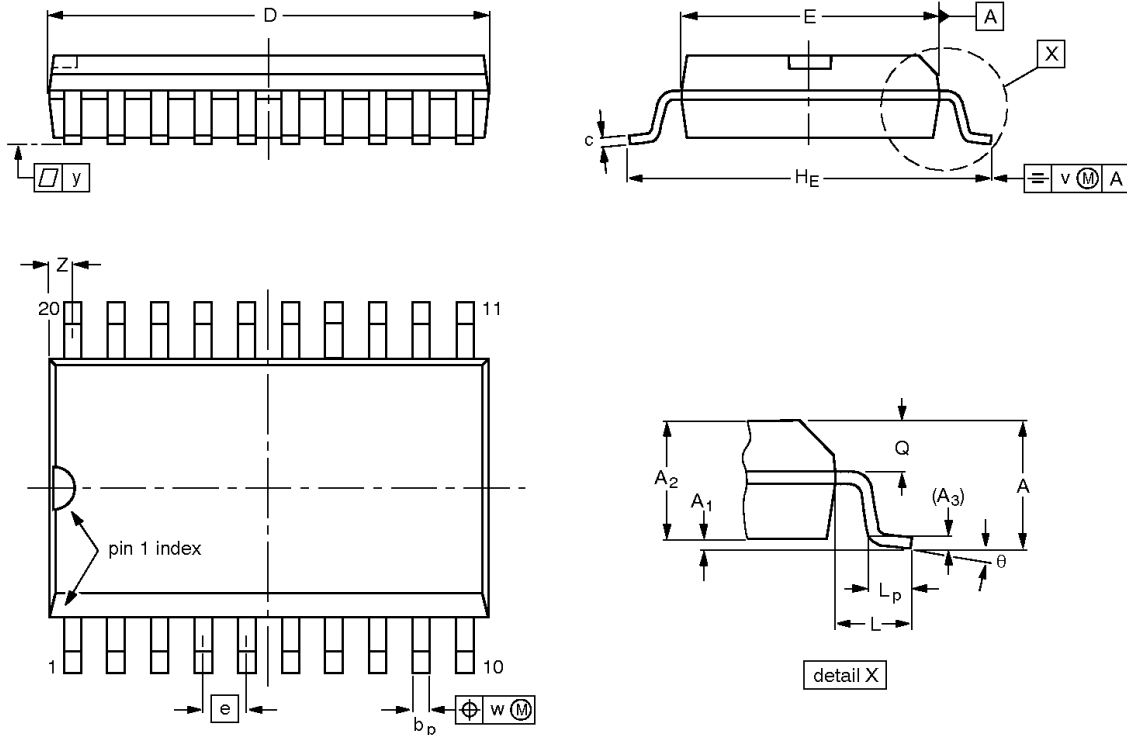
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT339-1		MO-150				95-02-04- 99-12-27

Octal bus switch with quad output enables

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SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT163-1	075E04	MS-013				-97-05-22 99-12-27

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REVISION HISTORY

Rev	Date	Description
_6	20030220	Product data (9397 750 11154); ECN 853-2131 29415 of 23 January 2003; supersedes data of 28 May 2002 (9397 750 09857). Modifications: <ul style="list-style-type: none">• Update product specifications
_5	20020528	Product data (9397 750 09857); ECN 853-2131 28322 of 28 May 2002.

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Data sheet status

Level	Data sheet status ^[1]	Product status ^[2] [3]	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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